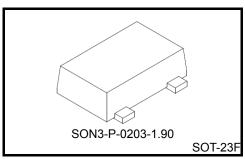
TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TCS20DLR

#### Digital Output Magnetic Sensor

#### **Feature**

Open-Drain Output
South-Pole and North-Pole Detections

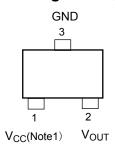


Weight: 11.0 mg (typ.)

#### Marking



### **Pin Assignment (Top View)**



#### **Function Table**

Magnetic Flux Density	Output		
$\geq B_{ON}$	L		
≤ B <sub>OFF</sub>	Z(Note 2)		

Note 1 : A  $0.47\mu F$  capacitor should be connected near the device. This condition will not guarantee successful operation. Check the performance thorough evaluation using the actual application to set the condition.

Note 2: In high impedance state.

#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics	Symbol	Rating	Unit
Supply Voltage	$V_{CC}$	V <sub>CC</sub> -0.5 to 6.0	
Output Voltage	V <sub>OUT</sub>	-0.5 to 6.0	٧
Output Diode Current	I <sub>OK</sub>	-10	mA
Output Current	lout	5	mA
Vcc/GND Current	Icc	±10	mA
Power Dissipation	P <sub>D</sub>	1 (Note 3)	W
Storage Temperature Range	T <sub>stg</sub>	-65 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 3: Mounted on a FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$ 

#### **Operating Ranges**

Characteristics	Symbol	Rating	Unit
Supply Voltage	V <sub>CC</sub>	2.3 to 3.6	V
Output Voltage	V <sub>OUT</sub>	0 to 5.5 (Note 4)	V
Output Current	loL	1.0	mA
Operating Temperature	T <sub>opr</sub>	-40 to 85	°C

Note 4:  $V_{CC} = 0.0 \text{ V}$  or when output impedance is high.

# DC Characteristics (Ta = 25°C)

Characteristics		Symbol	Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Output Voltage	Low Level	V <sub>OL</sub>	I <sub>OL</sub> = 1.0 mA	2.3	_	_	0.23	· V
				2.5	_	_	0.25	
				3.3			0.33	
				3.6			0.36	
Output Leakage Current		loff	V <sub>OUT</sub> = 5.5V	0		0.5	1	μΑ
Supply Current	Average Current	Icc	Current at pulse driving (Note 5, Fig. A)	2.3		7.3	13.2	μΑ
				2.5		8.5		
				3.3		12.8		
	Operating Current	I <sub>CC</sub> ON	Peak current (Note 5, Fig. A)	2.3		0.7	1.1	mA
				2.5		0.8		
				3.3		1.2		
Operating Frequency		f <sub>opr</sub>	(Fig. A)	2.3 to 3.6		25		Hz

Note 5: Supply current is pulsed periodically by internal circuit.

## **Magnetic Characteristics (Ta = 25°C)**

Cha	aracteristics	Symbol	Condition (Note 6and 7, Fig. B)	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Magnetic Flux Density Releasing Point  E	B <sub>ON</sub> S  B <sub>ON</sub> N	When output logic turns High to Low	2.3 to 3.6	_	3.4	4.4		
	Releasing Point	B <sub>OFF</sub> S  B <sub>OFF</sub> N	When output logic turns Low to High	2.3 to 3.6	0.9	2.0		mT*
	Hysteresis	B <sub>H</sub>	B <sub>ON</sub> - B <sub>OFF</sub>	2.3 to 3.6		1.4	_	

\*1 mT=10 Gauss

Note 6: Uniform magnetic field perpendicularly to the magnetic sensor.

Note 7: Output logic is High level with pull-up resistance.



Note: Direction of Magnetic field

#### Magnetic Field, B

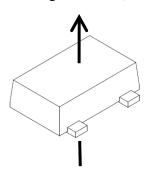
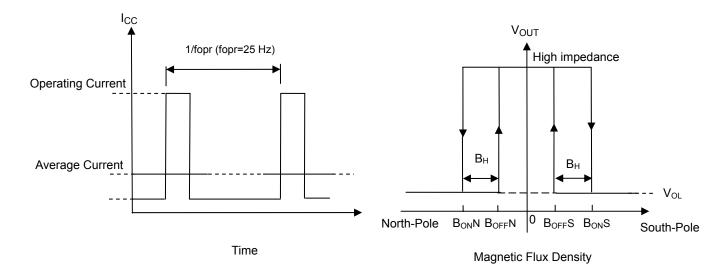


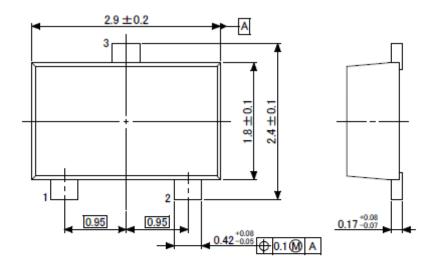
Fig. A :  $I_{CC}$  Characteristics

Fig. B : Operating Characteristics

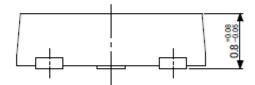


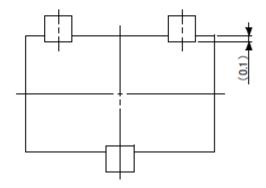
# **Package Dimension**

Unit: mm



5

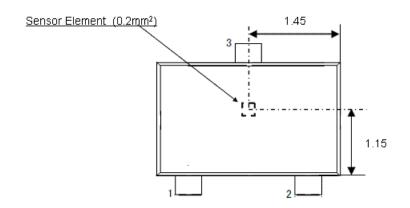


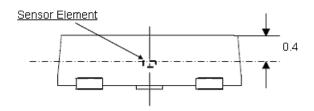


Weight: 11.0 mg (Typ.)

# **Layout of Sensor Element**

Unit: mm





6

Note: Dimensional tolerances are  $\pm 0.1$  mm, unless otherwise specified.

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